CLAIMS

1. A smart card comprising a card body (15) and an electronic module (1) placed in a recess (17) of the card body (15), characterised in that it further comprises at least one coloured coat (13) placed between the electronic module (1) and the bottom of the recess (17) of the card body (15).

2. A smart card according to claim 1, characterised in that the colour of the at least one coloured coat (13) is identical to the colour of the card body (15).

3. A smart card according to claim 1, characterised in that the electronic module (1) comprises protective resin (8) and in that at least one coloured coat (13) is applied on said protective resin (8).

4. A smart card according to claim 1, characterised in that at least one coloured coat (13) is applied on the bottom of the recess (17) of the card body (15).

5. A smart card according to claim 1, characterised in that the at least one coloured coat (13) is applied by means of ink printing.

6. A method for manufacturing a smart card comprising a card body (15) and an electronic module (1) placed in a recess (17) of the card body (15), characterised in that said method comprises at least one step (204) for applying at least one coloured coat (13) between the electronic module (1) and the bottom of the recess (17) of the card body (15).

7. A manufacturing method according to claim 6, characterised in that at least one application step (204) of the at least one coloured coat (13) is carried out on the bottom of the recess (17) of the card body (15).

8. A manufacturing method according to claim 6, characterised in that the electronic module (1) comprises protective resin (8) and in that at least one application step (204) of the at least one coloured coat (13) is carried out on said protective resin (8).

9. A manufacturing method according to the previous claim, characterised in that the step (204) for applying the at least one coloured coat (13) is carried out during the

encapsulation process (210), between a step (202) of encapsulating the electronic module (1) and a step (206) of inspecting said electronic module (1).

10. A manufacturing method according to claim 6, characterised in that the step (204) of applying the at least one coloured coat (13) is carried out by means of ink printing.

11. A manufacturing method according to the previous claim, characterised in that the printing step is carried out by stamping.

Claims

1. A smart card comprising a card body and an electronic module placed in a cavity of the card body, said electronic module comprising a microchip connected through connections with at least one electrical contact zone on the top of the cavity of the card body, and a protective resin in which said microchip and connections are coated, wherein the electronic module further comprises at least a coloured layer applied on the protective resin before placing the electronic module in the card body, so that a coloured coat is formed between the protective resin and the bottom of the cavity of the card body, said coloured coat being sufficiently opaque to reduce the visibility of the electronic module through the bottom of the card body.

2. The smart card according to claim 1, wherein the colour of the at least one coloured coat is identical to the colour of the card body.

3. The smart card according to claim 1, wherein at least one coloured coat is applied on the bottom of the recess of the card body.

4. The smart card according to claim 1, wherein the at least one coloured coat is applied by means of ink printing.

5. A method for manufacturing a smart card comprising:

providing a card body and an electronic module placed in a cavity of the card body, said electronic module comprising a microchip connected through connections with at least one electrical contact zone on the top of the cavity of the card body, and a protective resin in which said microchip and connections are coated,

applying at least a coloured layer on said protective resin before placing the electronic module in the card body, so that a coloured coat is formed between the protective resin and the bottom of the cavity of the card body, said coloured coat being sufficiently opaque to reduce the visibility of the electronic module through the bottom of the card body.

6. The manufacturing method according to claim **5**, wherein the colour of the at least one coloured coat is identical to the colour of the card body.

7. The manufacturing method according to claim **5**, wherein at least one coloured coat is applied on the bottom of the recess of the card body.

8. The manufacturing method according to claim **5**, wherein the step of applying the at least one coloured coat is carried out by means of ink printing.

9. The manufacturing method according to claim **8**, wherein the ink printing step is carried out by stamping.